

Quadruple Operational Amplifiers

1 Features

- 2-kV ESD Protection for:
 - LM224K, LM224KA
 - LM324K, LM324KA
 - LM2902K, LM2902KV, LM2902KAV
- Wide Supply Ranges
 - Single Supply: 3 V to 32 V (26 V for LM2902)
 - Dual Supplies: ± 1.5 V to ± 16 V (± 13 V for LM2902)
- Low Supply-Current Drain Independent of Supply Voltage: 0.8 mA Typical
- Common-Mode Input Voltage Range Includes Ground, Allowing Direct Sensing Near Ground
- Low Input Bias and Offset Parameters
 - Input Offset Voltage: 3 mV Typical
A Versions: 2 mV Typical
 - Input Offset Current: 2 nA Typical
 - Input Bias Current: 20 nA Typical
A Versions: 15 nA Typical
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage: 32 V (26 V for LM2902)
- Open-Loop Differential Voltage Amplification: 100 V/mV Typical
- Internal Frequency Compensation
- On Products Compliant to MIL-PRF-38535, All Parameters are Tested Unless Otherwise Noted. On All Other Products, Production Processing Does Not Necessarily Include Testing of All Parameters.

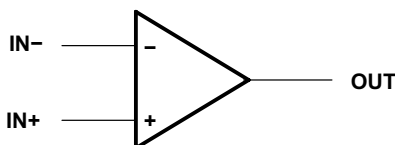
2 Applications

- Blu-ray Players and Home Theaters
- Chemical and Gas Sensors
- DVD Recorders and Players
- Digital Multimeter: Bench and Systems
- Digital Multimeter: Handhelds
- Field Transmitter: Temperature Sensors
- Motor Control: AC Induction, Brushed DC, Brushless DC, High-Voltage, Low-Voltage, Permanent Magnet, and Stepper Motor
- Oscilloscopes
- TV: LCD and Digital
- Temperature Sensors or Controllers Using Modbus
- Weigh Scales

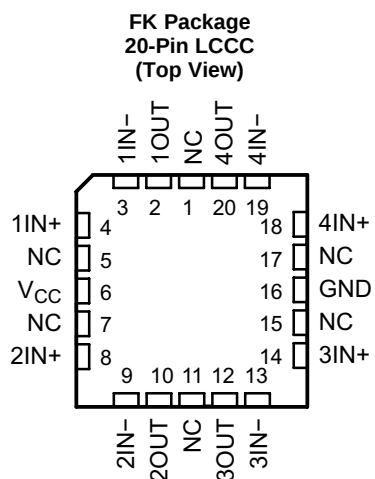
3 Description

These devices consist of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply or split supply over a wide range of voltages.

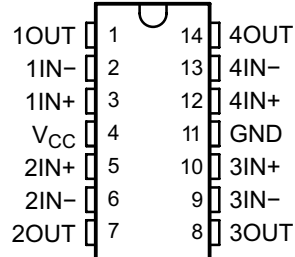
Symbol (Each Amplifier)



4 Pin Configuration and Functions



**D, DB, J, N, NS, PW, W
14-Pin SOIC, SSOP, CDIP, PDIP, SO, TSSOP, CFP
(Top View)**



Pin Functions

PIN			I/O	DESCRIPTION
NAME	LCCC NO.	SOIC, SSOP, CDIP, PDIP, SO, TSSOP, CFP NO.		
1IN-	3	2	I	Negative input
1IN+	4	3	I	Positive input
1OUT	2	1	O	Output
2IN-	9	6	I	Negative input
2IN+	8	5	I	Positive input
2OUT	10	7	O	Output
3IN-	13	9	I	Negative input
3IN+	14	10	I	Positive input
3OUT	12	8	O	Output
4IN-	19	13	I	Negative input
4IN+	18	12	I	Positive input
4OUT	20	14	O	Output
GND	16	11	—	Ground
NC	1	—	—	Do not connect
	5			
	7			
	11			
	15			
	17			
V _{CC}	6	4	—	Power supply

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

	LM2902		LMx24, LMx24x, LMx24xx, LM2902x, LM2902xx, LM2902xxx		UNIT
	MIN	MAX	MIN	MAX	
Supply voltage, V_{CC} ⁽²⁾	±13	26	±16	32	V
Differential input voltage, V_{ID} ⁽³⁾		±26		±32	V
Input voltage, V_I (either input)	−0.3	26	−0.3	to 32	V
Duration of output short circuit (one amplifier) to ground at (or below) $T_A = 25^\circ\text{C}$, $V_{CC} \leq 15\text{ V}$ ⁽⁴⁾	Unlimited		Unlimited		
Operating virtual junction temperature, T_J	150		150		°C
Case temperature for 60 seconds	FK package		260		°C
Lead temperature 1.6 mm (1/16 inch) from case for 60 seconds	J or W package		300		°C
Storage temperature, T_{stg}	−65	150	−65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
- (3) Differential voltages are at IN+, with respect to IN−.
- (4) Short circuits from outputs to VCC can cause excessive heating and eventual destruction.

5.2 ESD Ratings

			VALUE	UNIT
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV				
V _(ESD) Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101		±1000	
LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V				
V _(ESD) Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±500	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101		±1000	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	LM2902		LMx24, LMx24x, LMx24xx, LM2902x, LM2902xx, LM2902xxx		UNIT
	MIN	MAX	MIN	MAX	
V_{CC} Supply voltage	3	26	3	30	V
V_{CM} Common-mode voltage	0	$V_{CC} - 2$	0	$V_{CC} - 2$	V
T_A Operating free air temperature	LM124		−55	125	°C
	LM2904		−40	125	
	LM324		0	70	
	LM224		−25	85	

5.4 Thermal Information

THERMAL METRIC ⁽¹⁾	LMx24, LM2902					LMx24			UNIT
	D (SOIC)	DB (SSOP)	N (PDIP)	NS (SO)	PW (TSSOP)	FK (LCCC)	J (CDIP)	W (CFP)	
	14 PINS	14 PINS	14 PINS	14 PINS	14 PINS	20 PINS	14 PINS	14 PINS	
$R_{\theta JA}$ ⁽²⁾⁽³⁾ Junction-to-ambient thermal resistance	86	86	80	76	113	—	—	—	°C/W
$R_{\theta JC}$ ⁽⁴⁾ Junction-to-case (top) thermal resistance	—	—	—	—	—	5.61	15.05	14.65	

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).
(2) Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
(3) Maximum power dissipation is a function of T_{J(max)}, R_{θJA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_{J(max)} – T_A)/R_{θJA}. Operating at the absolute maximum T_J of 150°C can affect reliability.
(4) Maximum power dissipation is a function of T_{J(max)}, R_{θJA}, and T_C. The maximum allowable power dissipation at any allowable case temperature is P_D = (T_{J(max)} – T_C)/R_{θJC}. Operating at the absolute maximum T_J of 150°C can affect reliability.

5.5 Electrical Characteristics for LMx24 and LM324K

at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS ⁽¹⁾	T _A ⁽²⁾	LM124, LM224			LM324, LM324K			UNIT
					MIN	TYP ⁽³⁾	MAX	MIN	TYP ⁽³⁾	MAX	
V _{IO}	Input offset voltage		V _{CC} = 5 V to MAX, V _{IC} = V _{ICR} min, V _O = 1.4 V	25°C	3	5		3	7	mV	
			Full range		7		9				
I _{IO}	Input offset current		V _O = 1.4 V	25°C	2	30		2	50	nA	
			Full range		100		150				
I _{IB}	Input bias current		V _O = 1.4 V	25°C	–20	–150		–20	–250	nA	
			Full range		–300		–500				
V _{ICR}	Common-mode input voltage range		V _{CC} = 5 V to MAX	25°C	0 to V _{CC} – 1.5			0 to V _{CC} – 1.5		V	
			Full range		0 to V _{CC} – 2			0 to V _{CC} – 2			
V _{OH}	High-level output voltage		R _L = 2 kΩ	25°C	V _{CC} – 1.5			V _{CC} – 1.5		V	
			R _L = 10 kΩ	25°C							
			V _{CC} = MAX	R _L = 2 kΩ	Full range	26		26			
				R _L ≥ 10 kΩ	Full range	27	28		27		28
V _{OL}	Low-level output voltage		R _L ≤ 10 kΩ	Full range	5	20		5	20	mV	
A _{VD}	Large-signal differential voltage amplification		V _{CC} = 15 V, V _O = 1 V to 11 V, R _L ≥ 2 kΩ	25°C	50	100		25	100	V/mV	
				Full range	25		15				
CMRR	Common-mode rejection ratio		V _{IC} = V _{ICR} min	25°C	70	80		65	80	dB	
k _{SVR}	Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO})			25°C	65	100		65	100	dB	
V _{O1} / V _{O2}	Crosstalk attenuation		f = 1 kHz to 20 kHz	25°C	120			120		dB	
I _O	Output current	V _{CC} = 15 V, V _{ID} = 1 V, V _O = 0	Source	25°C	–20	–30	–60	–20	–30	–60	mA
				Full range	–10			–10			
		V _{CC} = 15 V, V _{ID} = –1 V, V _O = 15 V	Sink	25°C	10	20		10	20		
				Full range	5			5			
		V _{ID} = –1 V, V _O = 200 mV		25°C	12	30		12	30	μA	
I _{OS}	Short-circuit output current		V _{CC} at 5 V, V _O = 0, GND at –5 V	25°C		±40	±60		±40	±60	mA
I _{CC}	Supply current (four amplifiers)		V _O = 2.5 V, no load	Full range		0.7	1.2		0.7	1.2	mA
			V _{CC} = MAX, V _O = 0.5 V _{CC} , no load	Full range		1.4	3		1.4	3	

- (1) All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 30 V for the others.
(2) Full range is –55°C to 125°C for LM124, –25°C to 85°C for LM224, and 0°C to 70°C for LM324.
(3) All typical values are at T_A = 25°C

Electrical Characteristics for LMx24A and LM324KA (continued)

at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		T _A ⁽²⁾	LM124A			LM224A			LM324A, LM324KA			UNIT
				MIN	TYP ⁽³⁾	MAX	MIN	TYP ⁽³⁾	MAX	MIN	TYP ⁽³⁾	MAX	
V _{ICR} Common-mode input voltage range	V _{CC} = 30 V		25°C	0 to V _{CC} – 1.5			0 to V _{CC} – 1.5			0 to V _{CC} – 1.5			V
			Full range	0 to V _{CC} – 2			0 to V _{CC} – 2			0 to V _{CC} – 2			
V _{OH} High-level output voltage	R _L = 2 kΩ		25°C	V _{CC} – 1.5			V _{CC} – 1.5			V _{CC} – 1.5			V
	V _{CC} = 30 V	R _L = 2 kΩ	Full range	26			26			26			
		R _L ≥ 10 kΩ	Full range	27			27 28			27 28			
V _{OL} Low-level output voltage	R _L ≤ 10 kΩ		Full range	20			5 20			5 20			mV
A _{VD} Large-signal differential voltage amplification	V _{CC} = 15 V, V _O = 1 V to 11 V, R _L ≥ 2 kΩ		25°C	50 100			50 100			25 100			V/mV
			Full range	25			25			15			
CMRR Common-mode rejection ratio	V _{IC} = V _{ICR} min		25°C	70			70 80			65 80			dB
k _{SVR} Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO})			25°C	65			65 100			65 100			dB
V _{O1} / V _{O2} Crosstalk attenuation	f = 1 kHz to 20 kHz		25°C	120			120			120			dB
I _O Output current	V _{CC} = 15 V, V _{ID} = 1 V, V _O = 0	Source	25°C	–20			–20 –30 –60			–20 –30 –60			mA
			Full range	–10			–10						
	V _{CC} = 15 V, V _{ID} = –1 V, V _O = 15 V	Sink	25°C	10			10 20			1 20			
			Full range	5			5			5			
	V _{ID} = –1 V, V _O = 200 mV		25°C	12			12 30			12 30			μA
I _{OS} Short-circuit output current	V _{CC} at 5 V, GND at –5 V, V _O = 0		25°C	±40 ±60			±40 ±60			±40 ±60			mA
I _{CC} Supply current (four amplifiers)	V _O = 2.5 V, no load		Full range	0.7 1.2			0.7 1.2			0.7 1.2			mA
	V _{CC} = 30 V, V _O = 15 V, no load		Full range	1.4 3.			1.4 3			1.4 3			

5.6 Operating Conditions
 $V_{CC} = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
SR	Slew rate at unity gain	$R_L = 1\text{ M}\Omega$, $C_L = 30\text{ pF}$, $V_I = \pm 10\text{ V}$ (see Figure 7)	0.5	V/ μs
B_1	Unity-gain bandwidth	$R_L = 1\text{ M}\Omega$, $C_L = 20\text{ pF}$ (see Figure 7)	1.2	MHz
V_n	Equivalent input noise voltage	$R_S = 100\text{ }\Omega$, $V_I = 0\text{ V}$, $f = 1\text{ kHz}$ (see Figure 8)	35	nV/ $\sqrt{\text{Hz}}$

5.7 Typical Characteristics

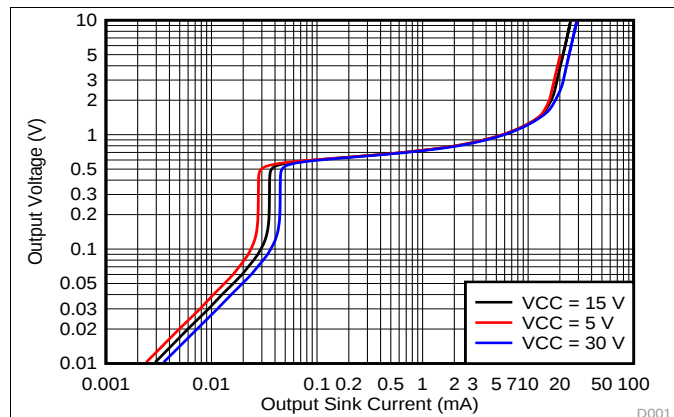


Figure 1. Output Sinking Characteristics

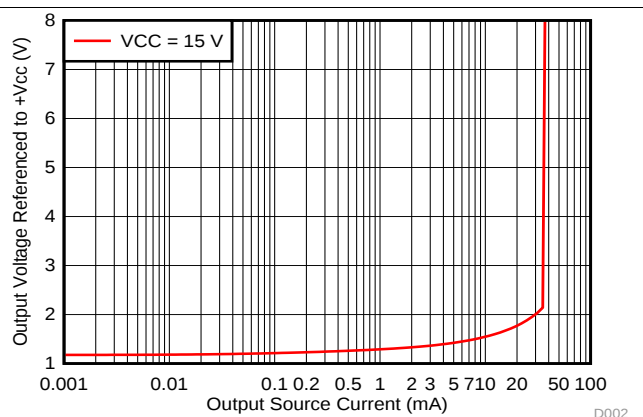


Figure 2. Output Sourcing Characteristics

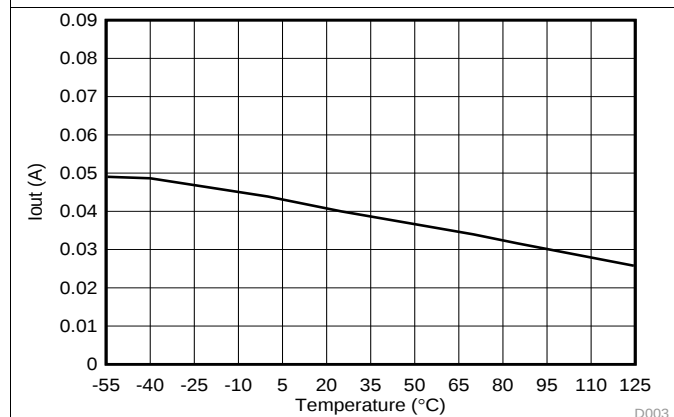


Figure 3. Source Current Limiting

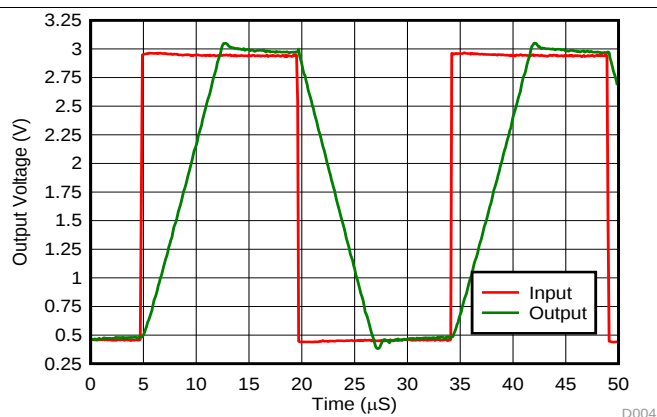


Figure 4. Voltage Follower Large Signal Response (50 pF)

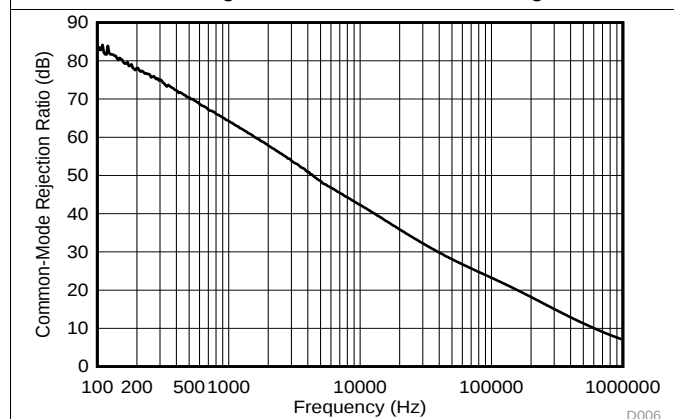


Figure 5. Common-Mode Rejection Ratio

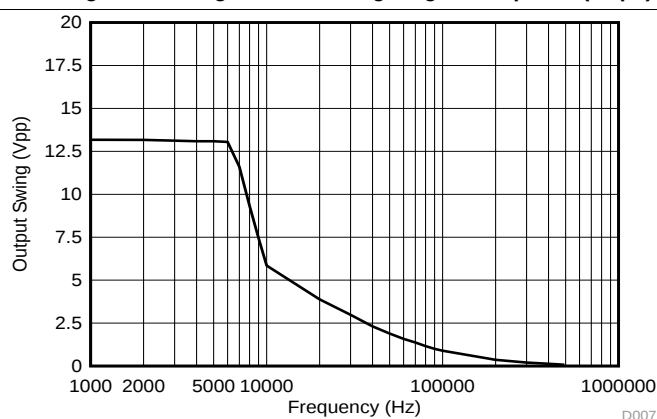


Figure 6. Maximum Output Swing vs. Frequency
(VCC = 15 V)

6 Parameter Measurement Information

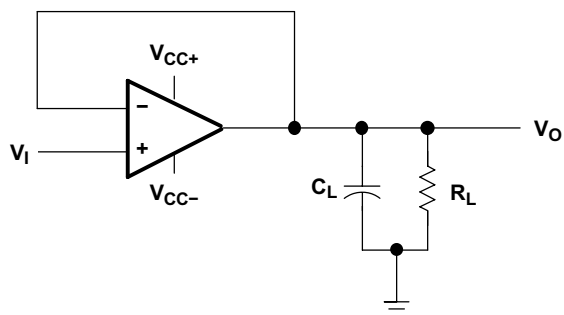


Figure 7. Unity-Gain Amplifier

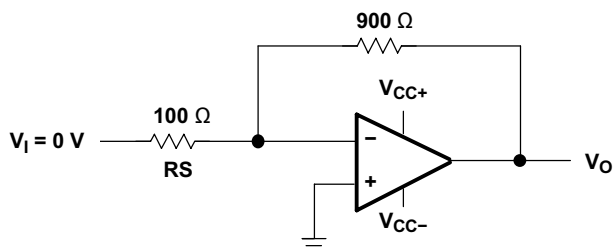


Figure 8. Noise-Test Circuit

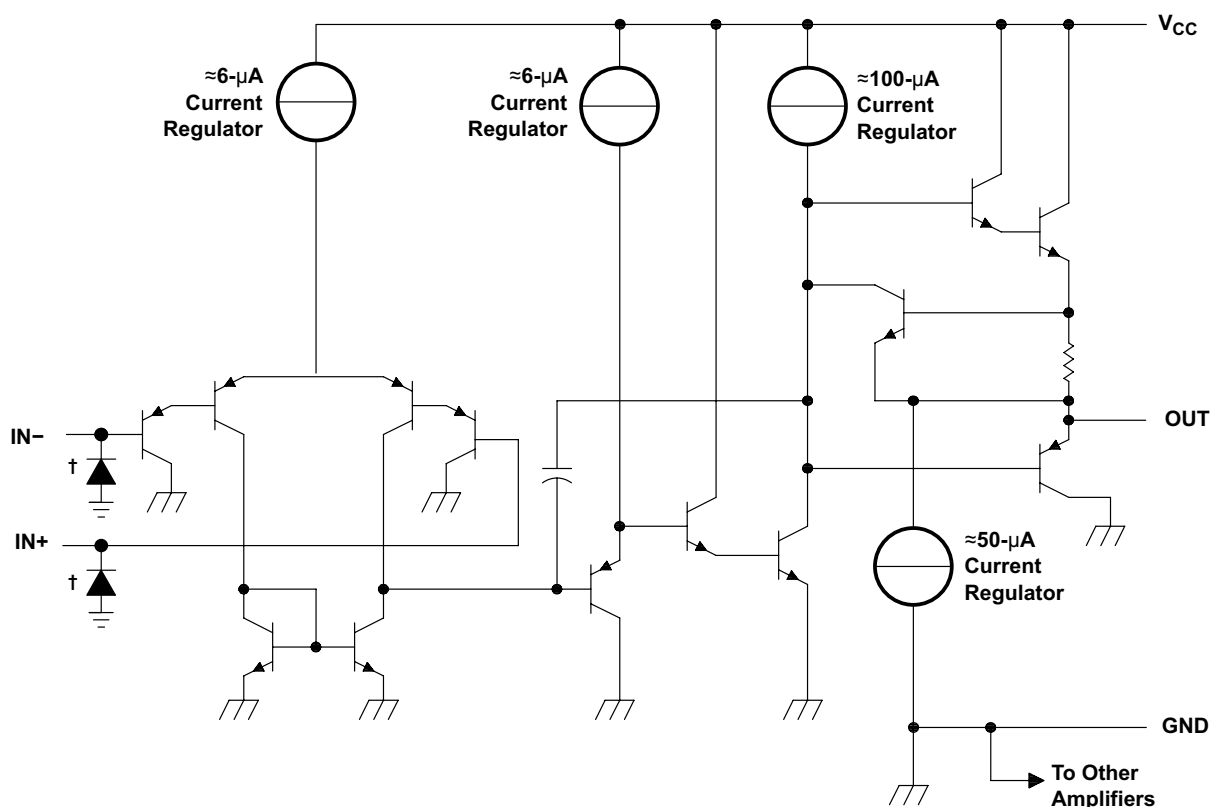
7 Detailed Description

7.1 Overview

These devices consist of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies also is possible if the difference between the two supplies is 3 V to 32 V (3 V to 26 V for the LM2902 device), and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

Applications include transducer amplifiers, DC amplification blocks, and all the conventional operational-amplifier circuits that now can be more easily implemented in single-supply-voltage systems. For example, the LM124 device can be operated directly from the standard 5-V supply that is used in digital systems and provides the required interface electronics, without requiring additional ± 15 -V supplies.

7.2 Functional Block Diagram



COMPONENT COUNT (total device)	
Epi-FET	1
Transistors	95
Diodes	4
Resistors	11
Capacitors	4

† ESD protection cells - available on LM324K and LM324KA only

Important statement:

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